

APG1608CGKC/T

1.6 x 0.8 x 0.25 mm (0603) SMD Chip LED Lamp

DESCRIPTIONS

- The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- · It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

FEATURES

- 1.6 mm x 0.8 mm SMD LED, 0.25 mm thickness
- Low power consumption
- Wide viewing angle
- · Compatible with automatic placement equipment
- Ideal for backlight and indicator
- Package: 4000 pcs / reel
- Moisture sensitivity level: 3
- RoHS compliant

APPLICATIONS

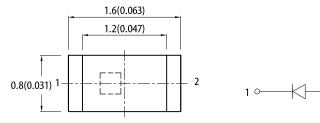
- Backlight
- Status indicator
- · Home and smart appliances
- · Wearable and portable devices
- Healthcare applications

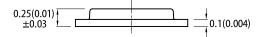
ATTENTION

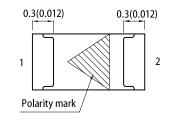
Observe precautions for handling electrostatic discharge sensitive devices

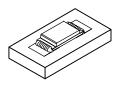


PACKAGE DIMENSIONS





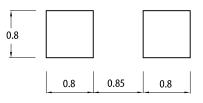




-0 2

RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



Mask open area ratio: 80% Mask thickness: 80~100um

Notes

1. All dimensions are in millimeters (inches).

Tolerance is ±0.1(0.004") unless otherwise noted.
 The specifications, characteristics and technical data described in the datasheet are subject to

change without prior notice. The device has a single mounting surface. The device must be mounted according to the specifications 4.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	lv (mcd) @ 20mA ^[2]		Viewing Angle ^[1]
			Min.	Тур.	201/2
APG1608CGKC/T	Green (AlGaInP)	Water Clear	20	50	120°

Notes

- 1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 2. Luminous intensity / luminous flux: +/-15%.
- 3. Luminous intensity value is traceable to CIE127-2007 standards.

Kingbright

ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Euritium Onlan	Value		1114
Parameter		Emitting Color	Тур.	Max.	Unit
Wavelength at Peak Emission $I_F = 20 \text{mA}$	λ_{peak}	Green	574	-	nm
Dominant Wavelength I _F = 20mA	λ_{dom} ^[1]	Green	570	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA	Δλ	Green	15	-	nm
Capacitance	С	Green	15	-	pF
Forward Voltage I _F = 20mA	V _F ^[2]	Green	2.1	2.6	V
Reverse Current (V _R = 5V)	I _R	Green	-	10	uA
Temperature Coefficient of λ_{peak} I_F = 20mA, -10°C $\leq T \leq 85^\circ C$	TC_{\lambdapeak}	Green	0.12	-	nm/°C
Temperature Coefficient of λ_{dom} I_F = 20mA, -10°C $\leq T \leq 85°C$	TC _{λdom}	Green	0.08	-	nm/°C
Temperature Coefficient of $~V_F$ I_F = 20mA, -10°C $\leq T \leq 85^\circ C$	TCv	Green	-1.9	-	mV/°C

Notes:

The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ±1nm.)
 Forward voltage: ±0.1V.
 Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

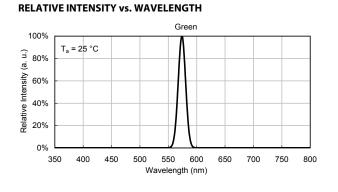
ABSOLUTE MAXIMUM RATINGS at $T_A=25^{\circ}C$

Parameter	Symbol	Value	Unit
Power Dissipation	P _D	78	mW
Reverse Voltage	V _R	5	V
Junction Temperature	Tj	115	°C
Operating Temperature	T _{op}	-40 to +85	°C
Storage Temperature	T _{stg}	-40 to +85	°C
DC Forward Current	I _F	30	mA
Peak Forward Current	I _{FM} ^[1]	150	mA
Electrostatic Discharge Threshold (HBM)	-	3000	V
Thermal Resistance (Junction / Ambient)	R _{th JA} ^[2]	510	°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} ^[2]	340	°C/W

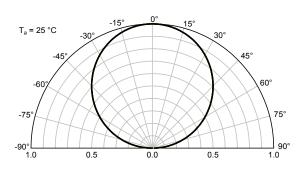
Notes: 1. /1/10 Duty Cycle, 0.1ms Pulse Width. 2. R_{in, Ja}, R_{in, JS} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad). 3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

Kingbright

TECHNICAL DATA



SPATIAL DISTRIBUTION



GREEN

50

40

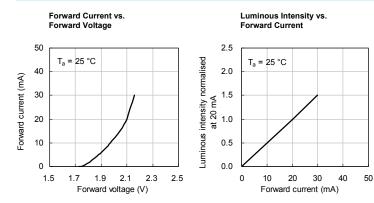
30

20 10

0

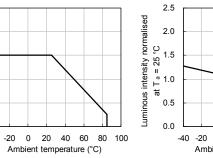
-40

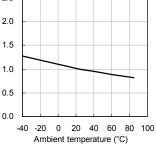
Permissible forward current (mA)



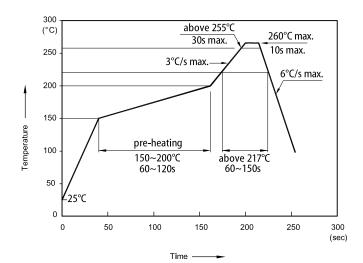
Forward Current Derating Curve

Luminous Intensity vs. Ambient Temperature





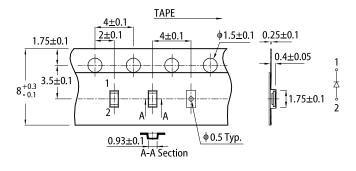
REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



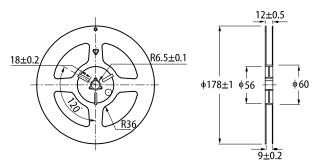
Notes.

- Don't cause stress to the LEDs while it is exposed to high temperature.
 The maximum number of reflow soldering passes is 2 times.
 Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

TAPE SPECIFICATIONS (units : mm)



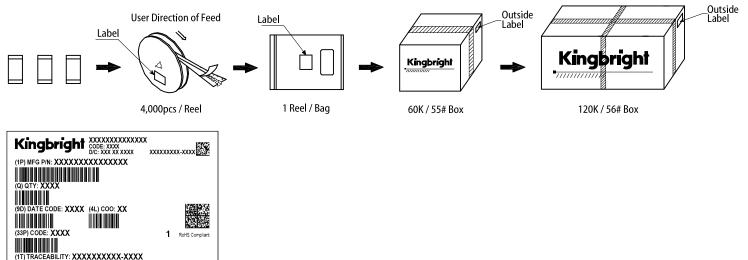
REEL DIMENSION (units : mm)



Kingbright

APG1608CGKC/T

PACKING & LABEL SPECIFICATIONS



PRECAUTIONARY NOTES

- 1. 2.
- The information included in this document reflects representative usage scenarios and is intended for technical reference only. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening 3.
- 4. The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright. All design applications should refer to Kingbright application notes available at <u>http://www.KingbrightUSA.com/Application</u>
- 5.
- 6. onNotes